L Number	Hits 3	Search Text 5916365.pn. or 4423701.pn. or 6497767.pn.	DB USPAT;	Time stamp 2004/09/17 12:45
-	,			1 2004/09/17 12:45 [
-		ostooo.bu. or itroior.bu. or ossiio.bu.	US-PGPUB	2004/03/17 12.43
()	498	atomic adj layer adj deposition	USPAT; US-PGPUB	2004/09/17 11:37
-	194	(atomic adj layer adj deposition) and chamber and region\$1	USPAT; US-PGPUB	2003/02/27 15:50
-	94	((atomic adj layer adj deposition) and chamber and region\$1) and @ad<=20010727	USPAT; US-PGPUB	2003/02/27 16:43
-	67	(((atomic adj layer adj deposition) and chamber and region\$1) and @ad<=20010727)	USPAT; US-PGPUB	2003/02/27 15:51
-	16	and wafer ((((atomic adj layer adj deposition) and chamber and region\$1) and @ad<=20010727) and wafer) and support	USPAT; US-PGPUB	2003/02/27 15:51
-	12	(((((atomic adj layer adj deposition) and chamber and region\$1) and @ad<=20010727) and wafer) and support) and heater	USPAT; US-PGPUB	2003/02/27 16:01
	1	5951776.pn.	USPAT; US-PGPUB	2003/02/27 16:06
-	1	6525747.pn.	USPAT; US-PGPUB	2003/02/27 16:40
-	1	"6174805".PN.	USPAT; US-PGPUB	2003/02/27 16:36
_	1	"6132514".PN.	USPAT; US-PGPUB	2003/02/27 16:36
-	1	"6071552".PN.	USPAT; US-PGPUB	2003/02/27 16:37
-	1	"5998871".PN.	USPAT; US-PGPUB	2003/02/27 16:37
_	1	"5998871".PN.	USPAT; US-PGPUB	2003/02/27 16:37
-	1	"5972785".PN.	USPAT; US-PGPUB	2003/02/27 16:37
-	1	"5916365".PN.	USPAT; US-PGPUB	2003/02/27 16:37
	1	"5416045".PN.	USPAT; US-PGPUB	2003/02/27 16:38
-	1	"5344792".PN.	USPAT; US-PGPUB	2003/02/27 16:38
-	1	"6190732".PN.	USPAT; US-PGPUB	2003/02/27 16:39
-	1	"6174377".PN.	USPAT; US-PGPUB	2003/02/27 16:39
-	1	"5935338".₽N.	USPAT; US-PGPUB	2003/02/27 16:40
-	1	"5879459".PN.	USPAT; US-PGPUB	2003/02/27 16:40
-	1	"5582866".PN.	USPAT; US-PGPUB	2003/02/27 16:40
-	655	700/121.ccls.	USPAT; US-PGPUB	2003/02/27 16:40
_	213	700/121.ccls. and deposition	USPAT; US-PGPUB	2003/02/27 16:41
-	113	(700/121.ccls. and deposition) and chamber	USPAT; US-PGPUB	2003/02/27 16:41
	90	((700/121.ccls. and deposition) and chamber) and @ad<=20010727	USPAT; US-PGPUB	2003/03/03 14:47
-	3	(((700/121.ccls. and deposition) and chamber) and @ad<=20010727) and piston	USPAT; US-PGPUB	2003/02/27 16:41
-	1	(((atomic adj layer adj deposition) and chamber and region\$1) and @ad<=20010727) and piston	USPAT; US-PGPUB	2003/02/27 16:50
-	1228	118/719.ccls.	USPAT; US-PGPUB	2003/02/27 16:50
-	55	118/719.ccls. and wafer and piston	USPAT; US-PGPUB	2003/02/27 16:50
-	16	(118/719.ccls. and wafer and piston) and aperture	USPAT; US-PGPUB	2003/02/27 16:51
-	15	kosowski.xa.	USPAT; US-PGPUB	2003/03/03 14:05

_	4183	deposition and wafer and support and chamber and region\$2 and temperature and	USPAT; US-PGPUB	2003/03/03 14:47
-	3626	two and gas (deposition and wafer and support and chamber and region\$2 and temperature and	USPAT; US-PGPUB	2003/03/03 17:34
-	167	two and gas) and @ad<=20010727 ((deposition and wafer and support and chamber and region\$2 and temperature and	USPAT; US-PGPUB	2003/03/03 14:50
-	11	two and gas) and @ad<=20010727) and piston (((deposition and wafer and support and chamber and region\$2 and temperature and	USPAT; US-PGPUB	2003/03/03 14:51
_	90	two and gas) and @ad<=20010727) and piston) and monolayer ((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<=20010727) and atomic	USPAT; US-PGPUB	2003/03/03 14:51
-	1413684	adj layer (((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<=20010727) and atomic	USPAT; US-PGPUB	2003/03/03 14:53
_	90	adj layer) and deposition near\$5 region\$1 (((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<=20010727) and atomic adj layer) and (deposition near\$5	USPAT; US-PGPUB	2003/03/03 16:18
_	1	region\$1) "6174805".PN.	USPAT;	2003/03/03 15:11
-	1	"6132514".PN.	US-PGPUB USPAT;	2003/03/03 15:11
_	1	"6071552".PN.	US-PGPUB USPAT;	2003/03/03 15:11
-	1	"5998871".PN.	US-PGPUB USPAT; US-PGPUB	2003/03/03 15:11
-	4	((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<=20010727) and	USPAT; US-PGPUB	2003/03/03 16:35
-	64	moveable adj support deposition and moveable adj support	USPAT; US-PGPUB	2003/03/03 16:35
-	62	(deposition and moveable adj support) and @ad<=20010727	USPAT; US-PGPUB	2003/03/03 16:37
-	25		USPAT;	2003/03/03 17:16
-	1	"5013400".PN.	USPAT; US-PGPUB	2003/03/03 16:45
_	1	"4990374".PN.	USPAT; US-PGPUB	2003/03/03 16:45
-	1	"4978412".PN.	USPAT; US-PGPUB	2003/03/03 16:46
-	1	"4963713".PN.	USPAT; US-PGPUB	2003/03/03 16:46
-	655	700/121.ccls.	USPAT; US-PGPUB	2003/03/03 17:16
-	2	700/121.ccls. and atomic adj layer adj deposition	USPAT; US-PGPUB	2003/03/03 17:33
-	21	4	USPAT;	2003/03/03 17:33
-	21	(interconnected with deposition with region \$2) and @ad <= 20010727	USPAT; US-PGPUB	2003/03/04 10:10
-	1	4423701.pn.	USPAT; US-PGPUB	2003/03/04 10:10
_	1	4423701.pn. and (heater or temperature)	USPAT; US-PGPUB	2003/03/04 11:13
	9	(US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-5292554-\$ or US-4423701-\$ or US-4664939-\$).did. or (US-20020197863-\$ or US-20020076490-\$ or US-20020056414-\$).did.	USPAT; US-PGPUB	2003/03/04 13:26

-	2	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	USPAT;	2003/03/04 13:51
į l	Ì	US-5916365-\$ or US-5292554-\$ or	US-PGPUB	
		US-4423701-\$ or US-4664939-\$).did. or		
}	1	(US-20020197863-\$ or US-20020076490-\$ or US-20020056414-\$).did.) and aperture		
_	0	4423701.pn. and gase	USPAT;	2003/03/04 13:51
		4423701.pn. and gase	US-PGPUB	2003/03/01 18:02
_	1	4423701.pn. and gas	USPAT:	2003/03/04 13:51
	1	1425701.pm. and gas	US-PGPUB	3000, 00, 00
ł _	1	4664939.pn. and gas	USPAT;	2003/03/04 14:09
	1	1001333.pii. diid yds	US-PGPUB	
_	2	((US-6524952-\$ or US-6387185-\$ or	USPAT;	2003/03/04 14:18
		US-5916365-\$ or US-5292554-\$ or	US-PGPUB	
1		US-4423701-\$ or US-4664939-\$) did. or		ļ
1		(US-20020197863-\$ or US-20020076490-\$ or		
		US-20020056414-\$).did.) and electrostatic		
_	0	((US-6524952-\$ or US-6387185-\$ or	USPAT;	2003/03/04 14:18
		US-5916365-\$ or US-5292554-\$ or	US-PGPUB	
		US-4423701-\$ or US-4664939-\$).did. or	,	
		(US-20020197863-\$ or US-20020076490-\$ or	,	
		US-20020056414-\$).did.) and piston		
-	18	atomic adj layer adj deposition and piston	USPAT;	2003/03/04 14:22
}			US-PGPUB	
-	437	deposition and chamber and support and	USPAT;	2003/03/04 14:23
		wafer and piston	US-PGPUB	
-	242	(deposition and chamber and support and	USPAT;	2003/03/04 14:23
	{	wafer and piston) and region and gas	US-PGPUB	
-	191	((deposition and chamber and support and	USPAT;	2003/03/04 14:25
•		wafer and piston) and region and gas) and	US-PGPUB	
		@ad<=20010727		
-	94	deposition and wafer adj support and	USPAT;	2003/03/04 14:25
		piston	US-PGPUB	
_	83		USPAT;	2003/03/04 14:26
		piston) and @ad<=20010727	US-PGPUB	
-	8	((deposition and wafer adj support and	USPAT;	2003/03/04 14:28
	1	piston) and @ad<=20010727) and wafer adj	US-PGPUB	
		support with piston		0000 (00 (04 14 00
-	1	5228502.pn.	USPAT;	2003/03/04 14:28
	ĺ		US-PGPUB	2003/07/25 14:05
_	10	(US-6524952-\$ or US-6387185-\$ or	USPAT;	2003/07/25 14:05
	}	US-5916365-\$ or US-5292554-\$ or US-4664939-\$ or US-4423701-\$ or	US-PGPUB	
	}	US-5518542-\$).did. or (US-20020076490-\$ or		
		US-20020197863-\$ or US-20020056414-\$).did.		
	1		USPAT;	2003/07/25 14:06
-	1	US-5916365-\$ or US-5292554-\$ or	US-PGPUB	2003/01/23 14.00
	1	US-4664939-\$ or US-4423701-\$ or	00 10100	
		US-5518542-\$).did. or (US-20020076490-\$ or		
		US-20020197863-\$ or		
	1	US-20020056414-\$).did.) and elevation		
_	8	((US-6524952-\$ or US-6387185-\$ or	USPAT;	2003/07/25 14:11
		US-5916365-\$ or US-5292554-\$ or	US-PGPUB	
		US-4664939-\$ or US-4423701-\$ or		
	1	US-5518542-\$).did. or (US-20020076490-\$ or	Ì	
	ł	US-20020197863-\$ or		
	1	US-20020056414-\$).did.) and vertical	*	
_	58		USPAT;	2003/07/28 11:14
			US-PGPUB	1
-	1	dworkin.in. and vendor	USPAT;	2003/07/28 11:56
1	1		US-PGPUB	
-	20721	image adj planes	USPAT;	2003/07/28 11:56
			US-PGPUB	
-	1159	(image adj planes) and 345/\$.ccls.	USPAT;	2003/07/28 11:56
	{		US-PGPUB	
-	680	118/729.ccls.	USPAT;	2003/11/17 16:10
			US-PGPUB	
-	411	118/729.ccls. and (vertical or elevation)	USPAT;	2003/11/17 16:10
	1		US-PGPUB	
-	306	(, , , , , , , , , , , , , , , , , , ,	USPAT;	2003/11/17 16:10
		elevation)) and deposition	US-PGPUB	

•				
_	50	((118/729.ccls. and (vertical or	USPAT;	2003/11/17 16:10
	}	elevation)) and deposition) and chuck	US-PGPUB	
_	48	(((118/729.ccls. and (vertical or	USPAT;	2003/11/17 16:11
		elevation)) and deposition) and chuck) and	US-PGPUB	
		(zone or chamber)		0000/11/17 16 16
-	12		USPAT;	2003/11/17 16:16
1		elevation)) and deposition) and chuck) and	US-PGPUB	
		(zone or chamber)) and pedestal	HODER	0002/11/17 16 10
_	9	(((((118/729.ccls. and (vertical or	USPAT;	2003/11/17 16:19
	ĺ	elevation)) and deposition) and chuck) and	US-PGPUB	
		(zone or chamber)) and pedestal) and		
	-	(((118/729.ccls. and (vertical or		
		elevation)) and deposition) and (pedestal same vertical \$3))		
_	32		USPAT;	2003/11/17 16:50
-	32	elevation)) and deposition) and (pedestal	US-PGPUB	2003/11/1/ 10:30
		same vertical\$3)	03-16100	
_	1	6143086.URPN.	USPAT	2003/11/17 16:27
	16		USPAT	2003/11/17 16:27
	10	"4938815" "5065698" "5094885"	001111	2000, 12, 1, 10,2
		"5135629" "5169684" "5192371"		
	}	"5213650" "5228501" "5238499"		
)	"5304249" "5474612" "5589224"		
		"5803977").PN.		
_	225		USPAT;	2003/11/17 16:51
		same vertical\$4) and (mult\$4 near5	US-PGPUB	
		chamber\$2)		
_	209	((wafer or semiconductor) and (pedestal	USPAT;	2003/11/17 16:51
	ĺ	same vertical\$4) and (mult\$4 near5	US-PGPUB	1
		chamber\$2)) and deposition		Ì
- '	16	5855675.URPN.	USPAT	2003/11/17 16:52
-	37	(((wafer or semiconductor) and (pedestal	USPAT;	2003/11/18 10:02
		same vertical\$4) and (mult\$4 near5	US-PGPUB	
		chamber\$2)) and deposition) and chuck and		
		heater		Ì
-	25	5909994.URPN.	USPAT	2003/11/18 09:55
_	58	(wafer or semiconductor) and vertical and	USPAT;	2003/11/18 10:03
		multichamber and deposition and chuck and	US-PGPUB	\
		heater		0000 (11 (10 10 00
-	66	(wafer or semiconductor) and vertical and	USPAT;	2003/11/18 10:03
	201	multichamber and deposition and chuck	US-PGPUB	2003/11/18 10:03
-	201	(wafer or semiconductor) and vertical and multichamber and deposition	USPAT; US-PGPUB	2003/11/18 10:03
	172	((wafer or semiconductor) and vertical and	USPAT;	2003/11/18 10:04
-	1/2	multichamber and deposition) and (pedestal	US-PGPUB	2003/11/18 10.04
		or support)	OD EGEOD	
_	11		USPAT;	2003/11/18 10:05
		and multichamber and deposition) and	US-PGPUB	2000,11,10 10.00
		(pedestal or support)) and 700/\$.ccls.	JU LOLOD	
-	2	6178660.URPN.	USPAT	2003/11/18 10:12
} _	13	("4795299" "4917556" "5228206"	USPAT	2003/11/18 10:12
}		"5423971" "5529657" "5611861"		1
		"5755938" "5759334" "5855675"		
	ĺ	"5863170" "5880924" "5882165"		
		"5886864").PN.		
_	1	4423701.pn.	USPAT;	2003/11/18 10:23
			US-PGPUB	
-	1	4423701.pn. and vertical	USPAT;	2003/11/18 10:23
	1	_	US-PGPUB	
-	15	(US-4423701-\$ or US-5292554-\$ or	USPAT;	2003/11/18 10:40
		US-5518542-\$ or US-4664939-\$ or	US-PGPUB	
		US-6524952-\$ or US-6387185-\$ or		
	1	US-5916365-\$ or US-6143086-\$ or		
	1	US-6497767-\$ or US-6178660-\$ or		
		US-5772773-\$ or US-6318945-\$).did. or		
		(US-20020056414-\$ or US-20020197863-\$ or		
		US-20020076490-\$).did.		
-		multizone and deposition and wafer	USPAT;	2003/11/18 10:45
1	51	marerzone and deposition and water		2000/11/10 10:45
			US-PGPUB	
_	25	(multizone and deposition and wafer) and vertical		2003/11/18 10:40

-	4	((multizone and deposition and wafer) and	USPAT;	2003/11/18 10:42
		vertical) and pedestal	US-PGPUB USPAT;	2003/11/18 10:42
-	1	6352593.pn.	US-PGPUB	2003/11/10 10.42
]_	220	(multizone or multi-zone) and deposition	USPAT;	2003/11/18 10:46
]	220	and wafer	US-PGPUB	
-	0	((multizone or multi-zone) and deposition	USPAT;	2003/11/18 10:46
		and wafer) and verticle	US-PGPUB	
-	126	((multizone or multi-zone) and deposition	USPAT;	2003/11/18 10:46
) ,	10.	and wafer) and vertical	US-PGPUB USPAT:	2003/11/18 10:46
_	104	(((multizone or multi-zone) and deposition and wafer) and vertical) and (support or	US-PGPUB	2003/11/16 10:46
1	Ì	pedestal)	05 10105	
_	63	((((multizone or multi-zone) and	USPAT;	2003/11/18 10:46
		deposition and wafer) and vertical) and	US-PGPUB	
		(support or pedestal)) and heater		
-	27	((((multizone or multi-zone) and	USPAT;	2003/11/18 11:12
		deposition and wafer) and vertical) and	US-PGPUB	
	ļ	(support or pedestal)) and heater) and		
	_	chuck 6413321.URPN.	USPAT	2003/11/18 10:50
_	2 17	6413321.0RPN. ("3627590" "4798165" "5045346"	USPAT	2003/11/18 10:50
	'	"5221414" "5230741" "5238499"		
		"5244730" "5350427" "5366585"		
}		"5374594" "5447570" "5589233"		!
		"5614055" "5855681" "5871811"		
		"5879128" "6020035").PN.	tion b.m	0000/11/10 11 10
-	1329	118/719.ccls.	USPAT; US-PGPUB	2003/11/18 11:12
_	73	118/719.ccls. and pedestal and vertical	USPAT;	2003/11/18 12:47
	/3	110//19.ccis. and pedestal and vertical	US-PGPUB	2003/11/10 12:17
\ _	450	118/719.ccls. and (pedestal or support)	USPAT;	2003/11/18 11:13
		and vertical	US-PGPUB	
-	25	(118/719.ccls. and pedestal and vertical)	USPAT;	2003/11/18 12:55
		and zone and gas	US-PGPUB	0000 (44 (40 40 55
-	253	118/719.ccls. and aperture	USPAT;	2003/11/18 12:55
}	171	(118/719.ccls. and aperture) and	US-PGPUB USPAT;	2003/11/18 12:55
_	1/1	vertical\$3	US-PGPUB	2003/11/10 12.33
_	112	((118/719.ccls. and aperture) and	USPAT;	2003/11/18 12:55
		vertical\$3) and wafer	US-PGPUB	
-	56	(((118/719.ccls. and aperture) and	USPAT;	2003/11/18 12:57
		vertical\$3) and wafer) and (region or	US-PGPUB	
	2	zone)	USPAT;	2003/11/18 13:26
_	3	((((118/719.ccls. and aperture) and vertical\$3) and wafer) and (region or	US-PGPUB	2003/11/10 13:20
	1	zone)) and piston	00 10100	
_	30	4430149.URPN.	USPAT	2003/11/18 13:13
-	823	700/121.ccls.	USPAT;	2003/11/18 13:27
	ł		US-PGPUB	
-	257	700/121.ccls. and deposition and wafer	USPAT;	2003/11/18 13:27
	1.1	(700/101 male and domestic and or 6-1)	US-PGPUB	2002/11/10 12-07
-	11	(700/121.ccls. and deposition and wafer) and zone and aperture	USPAT; US-PGPUB	2003/11/18 13:27
_	44138	438/\$.ccls. and deposition	USPAT;	2003/11/18 13:30
	14130	and deposition	US-PGPUB	2000, 11, 10 10.00
-	12	(438/\$.ccls. and deposition) and pedestal	USPAT;	2003/11/18 13:34
		and piston	US-PGPUB	
-	607	438/680.ccls.	USPAT;	2003/11/18 13:36
			US-PGPUB	0000/11/20 10 00
-	10	deposition and wafer adj support and (multizone or multi-zone) and aperture and	USPAT; US-PGPUB	2003/11/18 13:39
		vertical\$4 and heat\$4	OD-EGEOD	
_	4	cvd and pedestal same piston	USPAT;	2003/11/18 13:48
	1	possocial outline passour	US-PGPUB	
-	17	("4382739" "4513855" "4590380"	USPAT	2003/11/18 13:40
		"4619573" "4632624" "4746256"		
		"4801241" "4861222" "4872947"		
		"4894132" "4902531" "4915564" "4923594" "5051054" "5009199"		
		"4923584" "5051054" "5098198" "5108570" "5131460").PN.		
	J	0100010 0101400 1.EM.	L	L

_	607	438/680.ccls.	USPAT; US-PGPUB	2003/11/18 13:48
	26	438/680.ccls. and wafer adj support	USPAT; US-PGPUB	2003/11/18 14:04
-	25	438/680.ccls. and vertical and pedestal	USPAT; US-PGPUB	2003/11/18 14:04
_	19	(438/680.ccls. and vertical and pedestal) not (438/680.ccls. and wafer adj support)	USPAT; US~PGPUB	2003/11/18 14:09
_	8	("4951601" "5246881" "5366585" "5516367" "5558717" "5846332"	USPAT	2003/11/18 14:06
		"5853607" "5885356").PN.		
_	2	6063441.URPN.	USPAT	2003/11/18 14:08
	323	438/478.ccls.	USPAT; US-PGPUB	2003/11/18 14:09
_	14	438/478.ccls. and pedestal	USPAT; US-PGPUB	2003/11/18 14:12
_	690	wafer and deposition and support same screw and vertical	USPAT; US-PGPUB	2003/11/18 14:12
	245	(wafer and deposition and support same screw and vertical) and cvd	USPAT; US-PGPUB	2003/11/18 14:12
-	123	((wafer and deposition and support same	USPAT;	2003/11/18 14:13
_	47	screw and vertical) and cvd) and heater (((wafer and deposition and support same	US-PGPUB USPAT;	2003/11/18 14:20
		screw and vertical) and cvd) and heater) and zone	US-PGPUB	
-	24		USPAT	2003/11/18 14:20
	38	deposition and wafer and ball adj screw and zone	USPAT; US-PGPUB	2003/11/18 14:31
-	275	cvd and ball adj screw	USPAT; US-PGPUB	2003/11/18 14:31
_	6	(cvd and ball adj screw) and zone and aperture	USPAT; US-PGPUB	2003/11/18 14:31
_	0	aperture 6497767.URPN.	USPAT	2003/11/18 15:14
-	10	("5273588" "5418885" "5446825"	USPAT	2003/11/18 15:15
		"5688331" "5796074" "5855675" "5916370" "6001183" "6190113"		
_	1	"6190460").PN. 6497767.pn.	USPAT;	2003/11/18 16:30
_	1	6650315.pn.	US-PGPUB USPAT;	2003/11/18 16:49
-	1	6650346.pn.	US-PGPUB USPAT;	2003/11/18 16:50
_	46	("6630030" or "6579372" or "6578287" or	US-PGPUB USPAT;	2004/09/16 14:17
		"6572705" or "6551406" or "6511539" or "6481945" or "6478872" or "6447607" or	US-PGPUB	2001,03,10 11.17
		"6306216" or "6305314" or "6270572" or	1	
		"6231672" or "6200893" or "6197683" or "6183563" or "6174377" or "6139700" or		
		"6042652" or "6015590" or "5916365" or		
		"5879459" or "5855680" or "5835677" or		
-		"5807792" or "5796116" or "5730802" or "5711811" or "5674786" or "5503875" or		
1	ŀ	"5483919" or "5480818" or "5443647" or		
	ì	"5441703" or "5374570" or "5338362" or		
1	·	"5294286" or "5281274" or "5261959" or "5225366" or "4993357" or "4975252" or		
		"4834831" or "4413022" or "4389973" or		
	20	"4058430").pn.	поруш.	2004/00/16 16:46
	20	(US-6143086-\$ or US-5772773-\$ or US-4664939-\$ or US-4423701-\$ or	USPAT; US-PGPUB	2004/09/16 16:46
		US-5518542-\$ or US-5292554-\$ or		
		US-6387185-\$ or US-6524952-\$ or US-5916365-\$ or US-6497767-\$ or		
		US-6178660-\$ or US-6318945-\$ or		
		US-4430149-\$ or US-4949669-\$ or		
		US-5676869-\$ or US-5620523-\$ or US-6017396-\$).did. or (US-20020056414-\$ or		
		US-20020197863-\$ or US-20020076490-\$).did.		

- 10 ((US-6143086-\$ or US-5772773-\$ or US-4664939-\$ or US-4423701-\$ or US-5518542-\$ or US-5292554-\$ or US-6387185-\$ or US-6524952-\$ or US-5916365-\$ or US-6497767-\$ or US-6178660-\$ or US-6318945-\$ or US-4430149-\$ or US-4949669-\$ or	USPAT; US-PGPUB	2004/09/16 16:46	
US-4430149-\$ or US-4949669-\$ or US-5676869-\$ or US-5620523-\$ or US-6017396-\$).did. or (US-20020056414-\$ or US-20020197863-\$ or US-20020076490-\$).did.) and purge			i